

REMARKS

35 USC § 102

Claims 1-3, 10-14, 16 and 17 are rejected under 35 USC § 102(e) as being anticipated by Inose (US 6,385,407). The Applicant respectfully disagrees.

Claim 1 recites “a smart container assembly comprising: a) a hermetically sealed storage cavity; b) a monitoring assembly including 1) a sensing mechanism; 2) an I/O interface; and 3) a recording mechanism electrically coupled to both the sensing mechanism and the I/O interface for recording data obtained from both the sensing mechanism and the I/O interface, wherein the monitoring assembly is positioned outside of the hermetically sealed storage cavity in an environment that is sealed off from and different than the environment inside of the hermetically sealed storage cavity.” According to the claim, the storage cavity is hermetically sealed and the monitoring assembly, that includes the sensing mechanism, the I/O interface and the recording mechanism, are located outside the hermetically sealed storage container.

Inose discloses a container and a management system that includes a storage portion to accommodate an expendable product to be used by an apparatus; and a memory to store identification information that can be read only by an external device. The expendable product is contained with a container that is not hermetically sealed. The memory component is hermetically sealed, along with an antenna apparatus, to be a part of the expendable product packaging and yet to be protected from the expendable product (in this case, ink). Furthermore, there does not appear to be any I/O device or component in the Inose device. There is no information that is inputted into the memory component after it is hermetically sealed in the packaging – it only emits or transmits information to a read/write component.

In addition, Inose does not teach all of the claimed elements of the present application. “Anticipation requires the disclosure in a single prior art reference of each element of the claim under consideration.” *W. L. Gore & Assocs. v. Garlock, Inc.*, 721 F.2d 1540, 220 USPQ 303, 313

(Fed. Cir. 1983) (citing *Soundsciber Corp. v. United States*, 360 F.2d 954, 148 USPQ 298, 301 (Ct. Cl.), *adopted*, 149 USPQ 640 (Ct. Cl. 1966)) Further, the prior art reference must disclose each element of the claimed invention “**arranged as in the claim**”. *Lindermann Maschinenfabrik GmbH v. American Hoist & Derrick Co.*, 730 F.2d 1452, 221 USPQ 481, 485 (Fed. Cir. 1984) (citing *Connell v. Sears, Roebuck & Co.*, 722 F.2d 1542, 220 USPQ 193 (Fed. Cir. 1983)). Inose does not teach, suggest or motivate one of ordinary skill in the art of container design to produce a hermetically sealed storage cavity and a monitoring assembly that is not hermetically sealed and that is outside of the storage cavity, wherein the monitoring assembly includes a sensing mechanism, an I/O interface, and a recording mechanism.

Therefore, claim 1 of the present application is not anticipated by Inose. Furthermore, claims 2-3, 10-14, 16 and 17 are not anticipated by Inose by virtue of their dependence on claim 1 and by amendments presented herein.

35 USC § 103

Claims 4-9 and 15 are rejected under 35 USC § 103(a) as being obvious over Inose (US 6,385,407) in view of Besprozvanny et al (US 5,627,523). The Applicant respectfully disagrees.

Claim 1 recites “a smart container assembly comprising: a) a hermetically sealed storage cavity; b) a monitoring assembly positioned outside of the hermetically sealed storage cavity and including 1) a sensing mechanism; 2) an I/O interface; and 3) a recording mechanism electrically coupled to both the sensing mechanism and the I/O interface for recording data obtained from both the sensing mechanism and the I/O interface, wherein the monitoring assembly is positioned outside of the hermetically sealed storage cavity in an environment that is sealed off from and different than the environment inside of the hermetically sealed storage cavity.” According to the claim, the storage cavity is hermetically sealed and the monitoring assembly, that includes the sensing mechanism, the I/O interface and the recording mechanism, are located outside the hermetically sealed storage container.

Claim 9 recites “a smart container assembly comprising: a) a storage container that includes a monitoring assembly receiving cavity, a dip tube orifice, an outer wall surrounding and defining a storage cavity; b) a dip tube assembly hermetically sealed to the perimeter of the dip tube orifice; c) a monitoring assembly positioned and removably retained within the monitoring assembly receiving cavity; and d) a dip tube seal cap positioned within and hermetically sealed to an end of the dip tube assembly, the dip tube assembly and seal cap hermetically sealing the storage cavity, wherein the monitoring assembly is positioned outside of the hermetically sealed storage cavity in an environment that is sealed off from and different than the environment inside of the hermetically sealed storage cavity.”

Inose discloses a container and a management system that includes a storage portion to accommodate an expendable product to be used by an apparatus; and a memory to store identification information that can be read only by an external device. The expendable product is contained with a container that is not hermetically sealed. The memory component is hermetically sealed, along with an antenna apparatus, to be a part of the expendable product packaging and yet to be protected from the expendable product (in this case, ink). Furthermore, there does not appear to be any I/O device or component in the Inose device. There is no information that is inputted into the memory component after it is hermetically sealed in the packaging – it only emits or transmits information to a read/write component. Inose does not teach, suggest or motivate one of ordinary skill in the art of container design to produce a hermetically sealed storage cavity and a monitoring assembly that is not hermetically sealed and that is outside of the storage cavity, wherein the monitoring assembly includes a sensing mechanism, an I/O interface, and a recording mechanism. Therefore, based on a fair reading of Inose, one of ordinary skill in the art would not be able to conceive of or design the smart container and methods contained in the present application.

Besprozvanny et al. (US 5,627,523) teaches a liquid level sensor device, particularly adapted for use with corrosive and hazardous liquids, such as oil, for measuring the liquid level in a storage tank or vessel. Besprozvanny does not teach, suggest or motivate one of ordinary skill in the art of container design to produce a hermetically sealed storage cavity and a monitoring assembly that is

not hermetically sealed and that is outside of the storage cavity, wherein the monitoring assembly includes a sensing mechanism, an I/O interface, and a recording mechanism.

Neither the Inose nor the Besprozvanny references, alone or in combination, teach, suggest or motivate one of ordinary skill in the art of container design to produce a hermetically sealed storage cavity and a monitoring assembly that is not hermetically sealed and that is outside of the storage cavity, wherein the monitoring assembly includes a sensing mechanism, an I/O interface, and a recording mechanism. Therefore, claims 1 and 9 of the present application are allowable as not being obvious in view of Inose and/or Besprozvanny. Furthermore, claims 4-8 and 15 are also allowable as not being obvious in view Inose and/or Besprozvanny by virtue of their dependence on independent claims 1 and 9.

CLAIM AMENDMENTS

The provision " wherein the monitoring assembly is positioned outside of the hermetically sealed storage cavity in an environment that is sealed off from and different than the environment inside of the hermetically sealed storage cavity" that is added to both claims 1 and 9 is fully supported throughout the original specification, including page 4, wherein it is clearly suggested that the environment inside the hermetically sealed storage cavity is different from that of the environment where the monitoring assembly is located when it is stated that, in one embodiment, the environments become "more similar" – meaning that they are initially different from one another and then can become more similar (not the same, however).

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REQUEST FOR ALLOWANCE

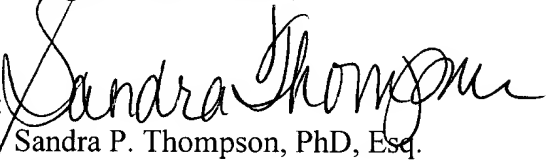
Claims 1-17 are pending in this application. The applicant requests allowance of all pending claims.

Respectfully submitted,

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CURRENT CLAIMS CONFORMING TO REVISED AMENDMENT PRACTICE

Claim 1 (Currently Amended): A smart container assembly comprising:

a hermetically sealed storage cavity;

a monitoring assembly ~~positioned outside of the hermetically sealed storage cavity and~~
including

a sensing mechanism;

an I/O interface;

and a recording mechanism electrically coupled to both the sensing mechanism and the
I/O interface for recording data obtained from both the sensing mechanism and the
I/O interface,

wherein the monitoring assembly is positioned outside of the hermetically sealed storage
cavity in an environment that is sealed off from and different than the
environment inside of the hermetically sealed storage cavity.

Claim 2 (Previously Amended): The assembly of claim 1 wherein the recording mechanism
comprises at least a first sub-mechanism and a second sub-mechanism wherein the first
sub-mechanism is electrically coupled to the sensing mechanism and the second sub-
mechanism is electrically coupled to an input portion of the I/O interface.

Claim 3 (Previously Amended): The assembly of claim 2 wherein the I/O interface comprises a
first sub interface electrically coupled to the first sub-mechanism of the recording
mechanism and a second sub interface coupled to the second sub-mechanism of the
recording mechanism.

Claim 4 (Original): The assembly of claim 1 wherein the container assembly further comprises a
monitoring assembly receiving cavity sized and dimensioned to receive and retain the

monitoring assembly, the receiving cavity having an environment more similar to the environment of the storage cavity than to the environment outside of the container assembly in regard to at least one condition the monitoring assembly is designed to monitor.

Claim 5 (Original): The assembly of claim 1 wherein the container assembly further comprises a monitoring assembly receiving cavity sized and dimensioned to receive and retain the monitoring assembly, the receiving cavity protruding into but being hermetically isolated from the storage cavity.

Claim 6 (Original): The assembly of claim 5 wherein the container further comprises an orifice providing an inlet into the storage cavity, a dip tube assembly retained by the orifice and extending into the storage cavity, and a seal cap, wherein the dip tube assembly and seal cap cooperate in hermetically sealing the orifice.

Claim 7 (Original): The assembly of claim 6 wherein the removal of the seal cap and/or dip tube assembly is the only way to break the hermetic seal of the storage cavity without creating a new opening into the storage cavity.

Claim 8 (Original): The assembly of claim 7 wherein the seal cap may be removed without breaking the hermetic seal between the dip tube assembly and the container, removal of the seal cap providing an outlet for any material stored in the storage cavity from the storage cavity, wherein any material flowing out of the storage cavity through the opening created by removal of the seal cap must flow through the dip tube of the dip tube assembly.

Claim 9 (Currently Amended): A smart container assembly comprising:

a storage container that includes a monitoring assembly receiving cavity, a dip tube orifice, an outer wall surrounding and defining a storage cavity;
a dip tube assembly hermetically sealed to the perimeter of the dip tube orifice;

a monitoring assembly positioned and removably retained within the monitoring assembly receiving cavity; and

a dip tube seal cap positioned within and hermetically sealed to an end of the dip tube assembly, the dip tube assembly and seal cap hermetically sealing the storage cavity,

wherein the monitoring assembly is positioned outside of the hermetically sealed dip tube in an environment that is sealed off from and different than the environment inside of the hermetically sealed storage cavity.

Claim 10 (Previously Amended): A method of transporting a material comprising:

providing the smart container assembly of claim 1;

placing the material to be transported within the container assembly;

transporting the container assembly containing the material to be transported; and

electronically querying the container assembly for information related to the contents or transportation of the container assembly.

Claim 11 (Original): The method of claim 10 further comprising electronically recording, prior to transportation of the container assembly, data relating to the material to be transported within the container assembly.

Claim 12 (Original): The method of claim 11 wherein electronically querying the container results in the container providing at least some of the electronically recorded data relating to the material transported within the container assembly.

Claim 13 (Original): The method of claim 10 wherein electronically querying the container results in the container providing information relating to the conditions the material was subjected to during transportation.

Claim 14 (Original): The method of claim 10 further comprising, after transportation of the container assembly, coupling the container to a processing unit programmed to query the

container for information relating to both the material transported within the container assembly and the conditions the material was subjected to during the transportation, and also programmed to use the material within the container assembly only if the contents and handling of the container assembly meet a standard programmed into or obtainable by the processing unit.

Claim 15 (Original): The method of claim 14 wherein placing the material within the container assembly comprises at least partially hermetically sealing an opening into a storage cavity containing the material with a dip tube assembly extending into the storage cavity.

Claim 16 (Original): The method of claim 15 wherein the material placed within the container assembly is a spin-on material.

Claim 17 (Original): The method of claim 16 wherein the material placed within the container assembly is a glass or organic polymer.